## **STTH810-Y**



# Automotive ultrafast recovery - high voltage diode

Datasheet - production data

### **Features**

- AEC-Q101 qualified
- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature

### **Description**

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability like automotive applications.

These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.

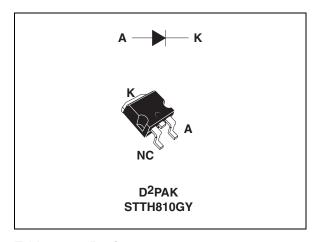


Table 1. Device summary

I <sub>F(AV)</sub>	8 A
V <sub>RRM</sub>	1000 V
T <sub>j</sub>	175 °C
V <sub>F</sub> (typ)	1.30 V
t <sub>rr</sub> (typ)	47 ns

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Table 2. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Param	Value	Unit		
$V_{RRM}$	Repetitive peak reverse voltage			1000	V
I <sub>F(RMS)</sub>	Forward rms current	Forward rms current			Α
I <sub>F(AV)</sub>	Average forward current, $\delta$ = 0.5 $T_c$ = 130 °C		8	Α	
I <sub>FRM</sub>	Repetitive peak forward current $t_p = 5 \mu s$ , $F = 5 kHz square$		100	Α	
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		60	Α	
T <sub>stg</sub>	Storage temperature range			-65 to + 175	°C
T <sub>j</sub>	Operating junction temperature range			-40 to +175	°C

### Table 3. Thermal parameters

	Symbol	Parameter	Value	Unit
Ī	R <sub>th(j-c)</sub>	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>B</sub> <sup>(1)</sup>	Povorce leekage aurrant	T <sub>j</sub> = 25 °C	V - V			5	
'R`´	$I_R^{(1)}$ Reverse leakage current $T_j = 125 ^{\circ}\text{C}$ $V_R = V_{RRM}$		2	20	μA		
		T <sub>j</sub> = 25 °C				2	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 100 °C	I <sub>F</sub> = 8 A		1.4	1.8	V
		T <sub>j</sub> = 150 °C			1.3	1.7	

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

To evaluate the conduction losses use the following equation:

$$P = 1.3 \text{ x } I_{F(AV)} + 0.05 I_{F}^{2}_{(RMS)}$$

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

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Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25 \text{ °C}$		64	85	ns
t <sub>rr</sub>	neverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25 \text{ °C}$		47	65	115
I <sub>RM</sub>	Reverse recovery current	$I_F = 8 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s},$ $V_R = 600 \text{ V}, T_j = 125 ^{\circ}\text{C}$		12	16	Α
S	Softness factor	$I_F = 8 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s},$ $V_R = 600 \text{ V}, T_j = 125 ^{\circ}\text{C}$		2		
t <sub>fr</sub>	Forward recovery time	$I_F = 8 \text{ A}$ $dI_F/dt = 50 \text{ A/}\mu\text{s}$ $V_{FR} = 1.5 \text{ x V}_{Fmax}, T_j = 25 \text{ °C}$			300	ns
V <sub>FP</sub>	Forward recovery voltage	$I_F = 8 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s},$ $T_j = 25 ^{\circ}\text{C}$		5.5		٧

Figure 1. Conduction losses versus average current

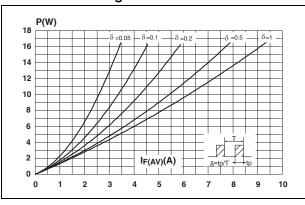


Figure 2. Forward voltage drop versus forward current

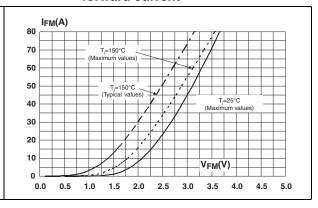


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

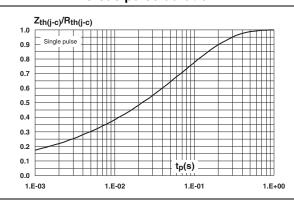
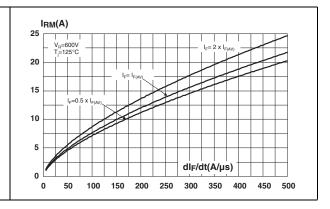
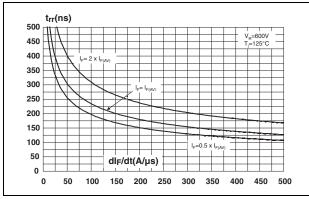


Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)



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Figure 5. Reverse recovery time versus dI<sub>F</sub>/dt Figure 6. Reverse recovery charges (typical values) versus dI<sub>F</sub>/dt (typical values)



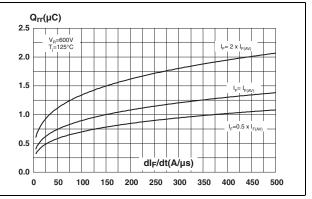
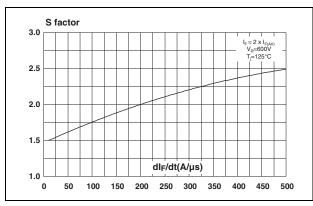


Figure 7. Softness factor versus  $dI_F/dt$  (typical values)

Figure 8. Relative variations of dynamic parameters versus junction temperature



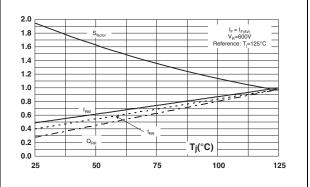


Figure 9. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values)

VFP(V)

45

40

T<sub>j=125°C</sub>

T<sub>j=125°C</sub>

35

30

25

20

15

10

5

dl<sub>F</sub>/dt(A/µs)

0

100

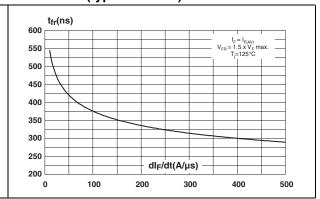
200

300

400

500

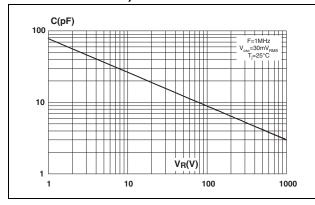
Figure 10. Forward recovery time versus dl<sub>F</sub>/dt (typical values)

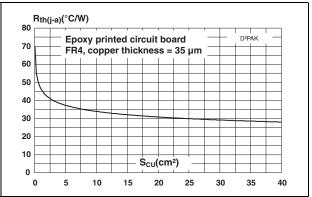


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Figure 11. Junction capacitance versus reverse voltage applied (typical values)

Figure 12. Thermal resistance junction to ambient versus copper surface under tab





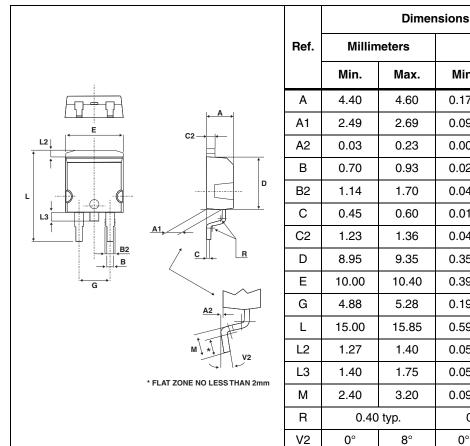
**Package information STTH810-Y** 

#### 2 **Package information**

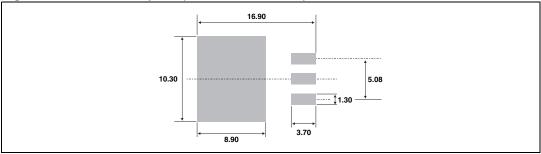
- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

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D<sup>2</sup>PAK dimensions Table 6.







Inches

Max.

0.181

0.106

0.009

0.037

0.067

0.024

0.054

0.368

0.409

0.208

0.624

0.055

0.069

0.126

8°

Min.

0.173

0.098

0.001

0.027

0.045

0.017

0.048

0.352

0.393

0.192

0.590

0.050

0.055

0.094

0°

0.016 typ.

# 3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH810GY-TR	STTH810GY	D <sup>2</sup> PAK	1.48 g	1000	Tape & reel

# 4 Revision history

Table 8. Document revision history

Date	Revision	Changes
24-Oct-2012	1	First issue.

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